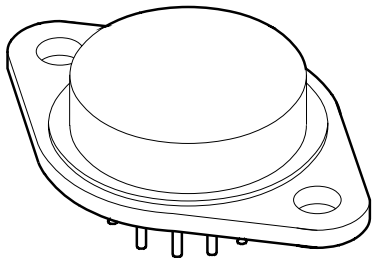
MIL-PRF-38534 AND 38535 CERTIFIED FACILITY

DUAL HIGH POWER OP-AMP 2541

FEATURES:

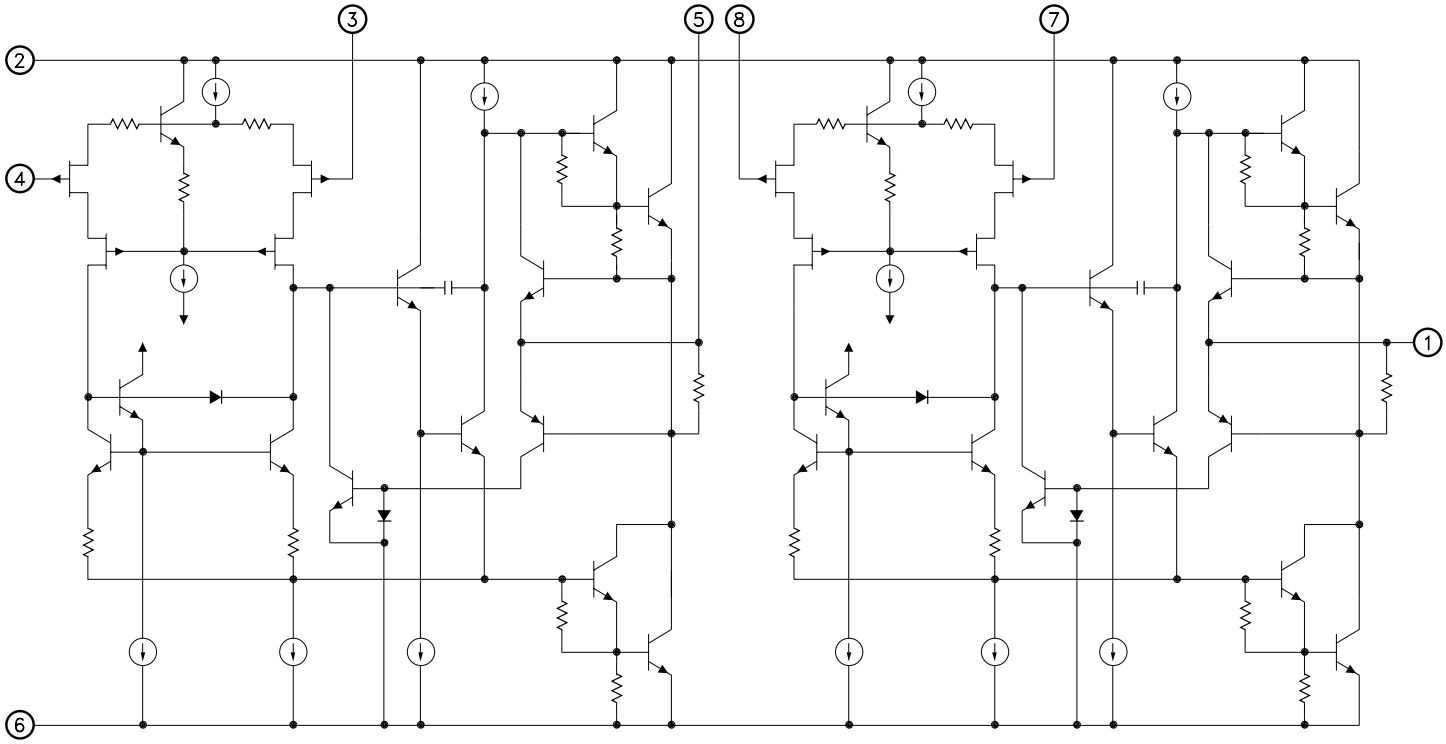
- Available as SMD #5962-9083801 HX and 5962-9083803HX
- High Output Current - 10 Amps Peak
- Wide Power Supply Range - ±10V to ±40V
- On Board Current Limit
- FET Input
- Isolated Case
- Second Source for OMA 2541SKB



DESCRIPTION:

The MSK2541 is a high power dual monolithic amplifier ideally suited for high power amplification and magnetic deflection applications. This amplifier is capable of operation at a supply voltage rating of 80 volts and can deliver guaranteed continuous output currents up to 5A per amplifier. The MSK2541 has internal current limit circuitry to protect the amplifier and load from transients. The MSK2541 is available in a hermetically sealed 8 pin TO3 package that is isolated from internal circuitry. This allows for convenient bolt down heat sinking when necessary.

EQUIVALENT SCHEMATIC



TYPICAL APPLICATIONS

- Servo Amplifer
- Motor Driver
- Audio Amplifier
- Programmable Power Supply
- Bridge Amplifier

PIN-OUT INFORMATION

1 Output B
2 Positive Power Supply
3 Non-Inverting Input A
4 Inverting Input A
8 Inverting Input B
7 Non-Inverting Input B
6 Negative Power Supply
5 Output A

ABSOLUTE MAXIMUM RATINGS ⑩

±V_{CC}	Voltage Supply	±40V
I_{OUT}	Peak Output Current	See S.O.A.
V_{IN}	Differential Input Voltage	±V_{CC}
V_{IN}	Common Mode Input Voltage	±V_{CC}
T_C	Case Operating Temperature Range	
	MSK2541B	-55°C to +125°C
	MSK2541	-40° to +85°
T_{ST}	Storage Temperature Range ⑪	-65°C to +150°C
T_{LD}	Lead Temperature Range (10 Seconds)	300°C
T_J	Junction Temperature	150°C

ELECTRICAL SPECIFICATIONS ⑨

Parameter	Test Conditions	Group A Subgroup	MSK2541B			MSK2541 ⑤			Units
			Min.	Typ.	Max.	Min.	Typ.	Max.	
STATIC									
Supply Voltage Range ② ④		-	±10	±35	±40	±10	±35	±40	V
Quiescent Current	Total - Both Amplifiers V_{IN} = 0V	1, 2, 3	-	±40	±60	-	±40	±60	mA
INPUT									
Input Offset Voltage	V_{IN} = 0V	1	-	±0.1	±1.5	-	±1.0	±10	mV
Input Offset Voltage Drift	V_{IN} = 0V	2, 3	-	±15	±50	-	±15	-	µV/°C
Input Bias Current ④	V_{CM} = 0V Either Input	1	-	±4	±50	-	±4	±100	pA
		2, 3	-	±10	±150	-	±10	-	nA
Input Offset Current ④	V_{CM} = 0V	1	-	2.0	30	-	2.0	30	pA
		2, 3	-	-	50	-	-	-	nA
Input Capacitance		-	-	5	-	-	5	-	pF
Imput Impedance ④	F = DC	-	-	10^{12}	-	-	10^{12}	-	W
Common Mode Rejection Ratio ④	F = DC V_{CM} = ±22V	-	95	113	-	90	113	-	dB
Power Supply Rejection Ratio ④	V_{CC} = ±10V to ±40V	-	-	90	-	-	90	-	dB
OUTPUT									
Output Voltage Swing	R_L = 5.6Ω F ≤ 10 KHz	4	±28	±29	-	±28	±29	-	V
	R_L = 10Ω F = 10 KHz	5, 6	±30	±31	-	-	-	-	V
Output Current	R_L = 5.6Ω F ≤ 10 KHz	4	±5	±8	-	±5	±8	-	A
	R_L = 10Ω F = 10 KHz	5, 6	±3.0	-	-	-	-	-	A
Settling Time ③ ④	0.1% 2V step	-	-	2	-	-	2	-	µS
Power Bandwidth	R_L = 10Ω V_O = 20 V_{RMS}	4	45	55	-	40	50	-	KHz
TRANSFER CHARACTERISTICS									
Slew Rate	V_{OUT} = ±10V R_L = 10Ω	4	6	10	-	6	10	-	V/µS
Open Loop Voltage Gain ④	F = 10 Hz R_L = 10 KΩ	4	95	100	-	90	100	-	dB
		5, 6	85	-	-	-	-	-	dB
THERMAL RESISTANCE ④									
θJC (Junction to Case)	One Amplifier, DC Output	-	-	1.4	1.9	-	1.9	2.2	°C/W
θJC	One Amplifier, AC Output F > 60	-	-	1.25	1.5	-	1.7	1.8	°C/W
θJC	Both Amplifiers, DC Output	-	-	0.9	1.2	-	1.2	1.5	°C/W
θJC	Both Amplifiers, AC Output F > 60	-	-	0.8	1.0	-	1.1	1.3	°C/W
θJA (Junction to Ambient)	No Heat Sink	-	-	30	-	-	30	-	°C/W

NOTES:

① Unless otherwise specified: ±V_{CC} = ±34 V_{DC}, all specs are per amplifier.

② Electrical specifications are derated for power supply voltages other than ±34 V_{DC}.

③ AV = -1, measured in false summing junction circuit.

④ Guaranteed by design but not tested. Typical parameters are for reference only.

⑤ Industrial grade devices shall be tested to subgroups 1 and 4 unless otherwise specified.

⑥ Military grade devices ('B' suffix) shall be 100% tested to subgroups 1, 2, 3 and 4.

⑦ Subgroup 5 and 6 testing available upon request.

⑧ Subgroup 1, 4 $T_A = T_C$ = +25°C
Subgroup 2, 5 $T_A = T_C$ = +125°C
Subgroup 3, 6 $T_A = T_C$ = -55°C

⑨ Reference DSCC SMD 5962-9083801 and 5962-9083803 for electrical specifications for devices purchased as such.

⑩ Continuous operation at or above absolute maximum ratings may adversely effect the device performance and/or life cycle.

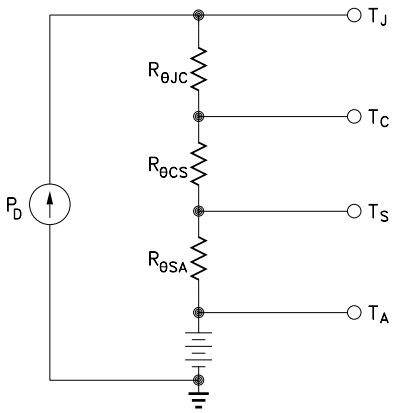
⑪ Internal solder reflow temperature is 180°C, do not exceed.

APPLICATION NOTES

HEAT SINKING

To select the correct heat sink for your application, refer to the thermal model and governing equation below.

Thermal Model:



Governing Equation:

$T_J = P_D \times (R_{\theta JC} + R_{\theta CS} + R_{\theta SA}) + T_A$

Where

T_J = Junction Temperature
P_D = Total Power Dissipation
$R_{\theta JC}$ = Junction to Case Thermal Resistance
$R_{\theta CS}$ = Case to Heat Sink Thermal Resistance
$R_{\theta SA}$ = Heat Sink to Ambient Thermal Resistance
T_C = Case Temperature
T_A = Ambient Temperature
T_S = Sink Temperature

Example:

In our example the amplifier application requires each output to drive a 20 volt peak sine wave across a 10 ohm load for 2 amps of output current. For a worst case analysis we will treat the 2 amps peak output current as a D.C. output current. The power supplies are ±35 VDC.

1.) Find Power Dissipation
P_D = [(quiescent current) X (+V_{CC} - (-V_{CC}))] + [(V_{CC} - V_O) X I_{OUT}]
= (30 mA) X (70V) + (15V) X (2A)+(15V)x(2A)
= 2.1W + 60W
= 62.1W
2.) For conservative design, set T_J = +150°C
3.) For this example, worst case T_A = +25°C
4.) $R_{\theta JC}$ = 1.2°C/W typically
5.) $R_{\theta CS}$ = 0.15°C/W for most thermal greases
6.) Rearrange governing equation to solve for $R_{\theta SA}$
$R_{\theta SA}$ = (T_J - T_A) / P_D - ($R_{\theta JC}$) - ($R_{\theta CS}$)
= (150°C - 25°C) / (62.1W) - (1.2°C/W) - (0.15°C/W)
= ≅0.66°C/W

The heat sink in this example must have a thermal resistance of no more than 0.66°C/W to maintain a junction temperature of no more than +150°C. Since this value of thermal resistance may be difficult to find, other measures may have to be taken to decrease the overall power dissipation. Refer to the "Heat Sinking Options" application note offered by MSK.

POWER SUPPLY CONNECTIONS

The MSK2541 maximum supply voltage is specified as ±40V. However, single sided or unbalanced power supply operation is permissible as long as the total power supply voltage does not exceed 80V. Caution should be exercised when routing high current printed circuit paths. Generally, these paths should not be placed near low level, high impedance input circuitry to avoid oscillations.

During prototype evaluation, power supply current limiting is strongly advised to avoid damaging the device. See the application note entitled "Current Limit" for an explanation of the limitations of the MSK2541 on board current limit.

POWER SUPPLY BYPASSING

Both the negative and the positive power supplies must be effectively decoupled with a high and low frequency bypass circuit to avoid power supply induced oscillation. An effective decoupling scheme consists of a 0.1 microfarad ceramic capacitor in parallel with a 4.7 microfarad tantalum capacitor from each power supply pin to ground. It is also a good practice with very high power op-amps, such as the MSK2541, to place a 30-50 microfarad non-electrolytic capacitor with a low effective series resistance in parallel with the other two power supply decoupling capacitors. This capacitor will eliminate any peak output voltage clipping which may occur due to poor power supply load regulation. All power supply decoupling capacitors should be placed as close to the package power supply pins as possible (pins 3 and 6).

CURRENT LIMIT

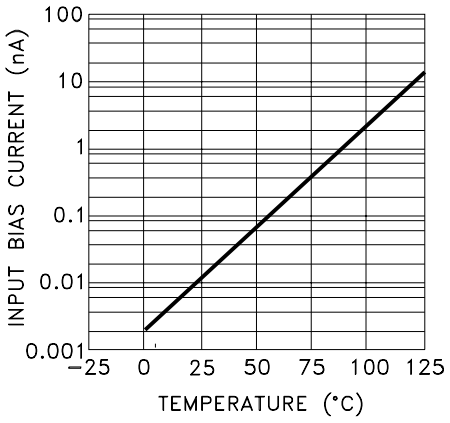
The internal current limit should not be used as a short circuit protection scheme. When the output is directly shorted to ground, the power supply voltage is applied across the output transistor that is conducting. If the power supplies were set to ±40V and the output was shorted to ground, the transistor that is conducting current would see 40V from its emitter to its collector. Referring to the safe operating area curve shows when [V_{CC}-V_{OUT}]=40V, the maximum safe output current (I_O) at T_C=25°C is 1.5A. In this case the amplifier would not be protected by the internal current limit and would probably be damaged. The internal current limit is provided as a protection against unintentional load conditions which may require larger amounts of load current than the amplifier is rated for.

SAFE OPERATING AREA

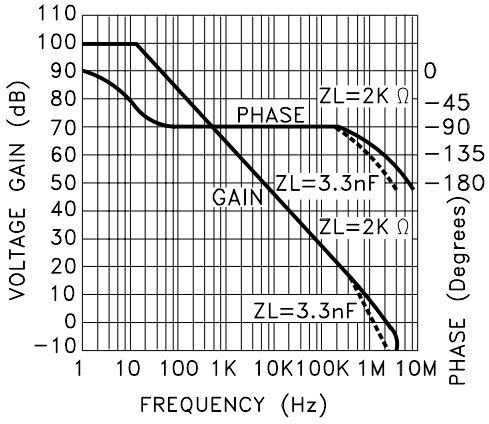
The safe operating area curve is a graphical representation of the power handling capability of the amplifier under various conditions. The wire bond current carrying capability, transistor junction temperature and secondary breakdown limitations are all incorporated into the safe operating area curves. All applications should be checked against the S.O.A. curves to ensure high M.T.T.F.

TYPICAL PERFORMANCE CURVES

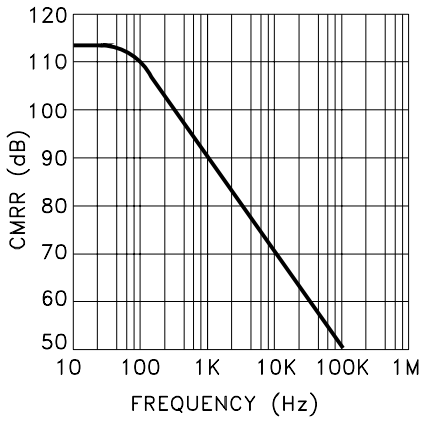
INPUT BIAS CURRENT vs TEMPERATURE



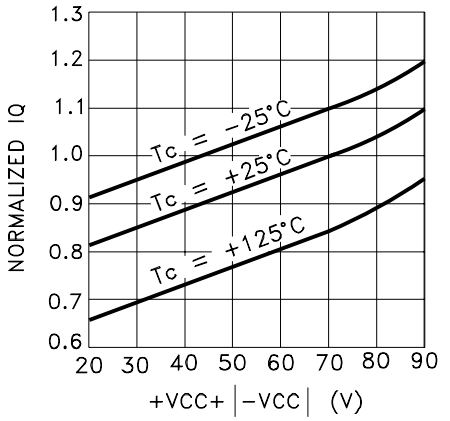
OPEN LOOP GAIN AND PHASE vs FREQUENCY



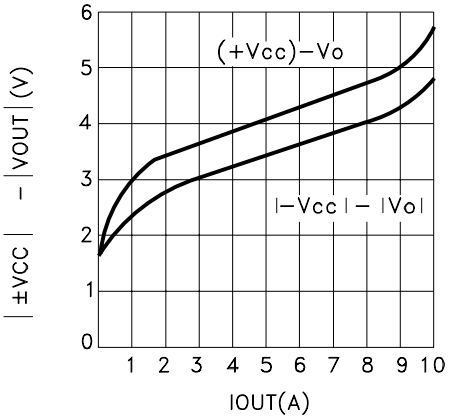
COMMON MODE REJECTION vs FREQUENCY



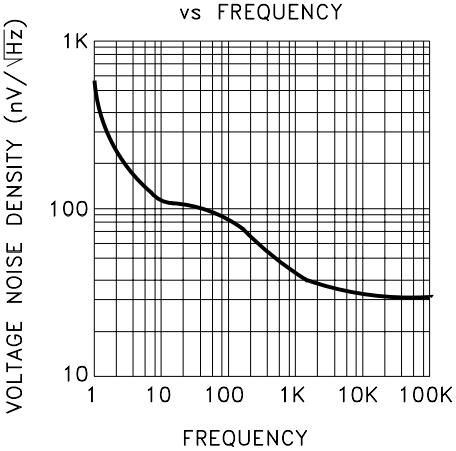
NORMALIZED QUIESCENT CURRENT vs TOTAL POWER SUPPLY VOLTAGE



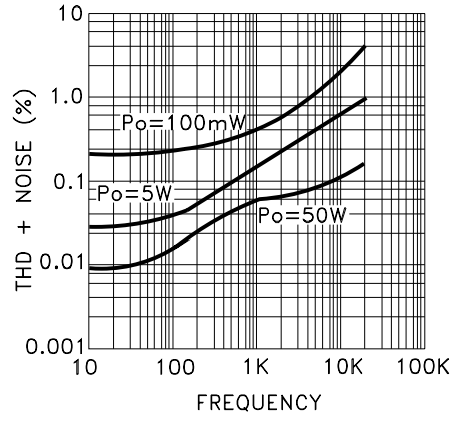
OUTPUT VOLTAGE SWING vs OUTPUT CURRENT



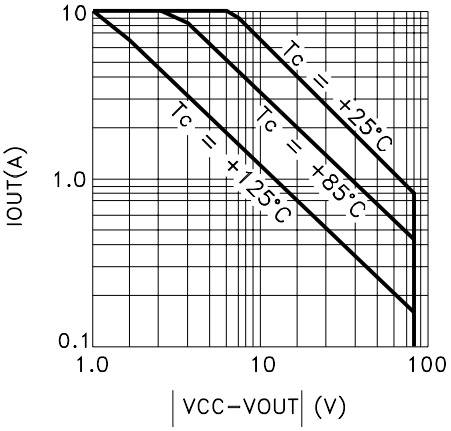
VOLTAGE NOISE DENSITY vs FREQUENCY



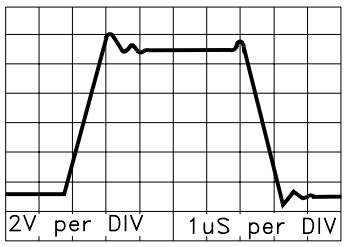
TOTAL HARMONIC DISTORTION vs FREQUENCY



SAFE OPERATING AREA

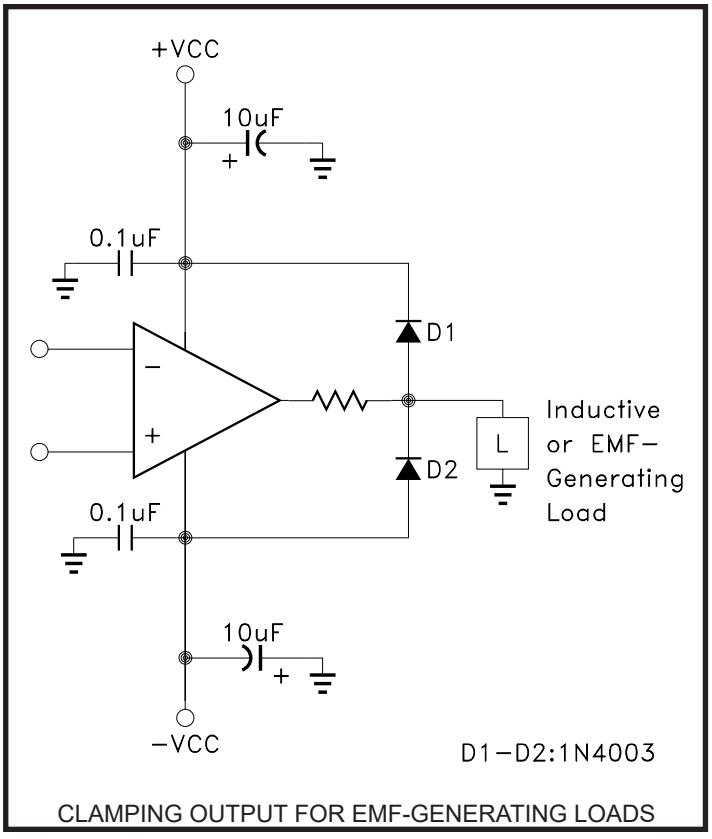


DYNAMIC RESPONSE

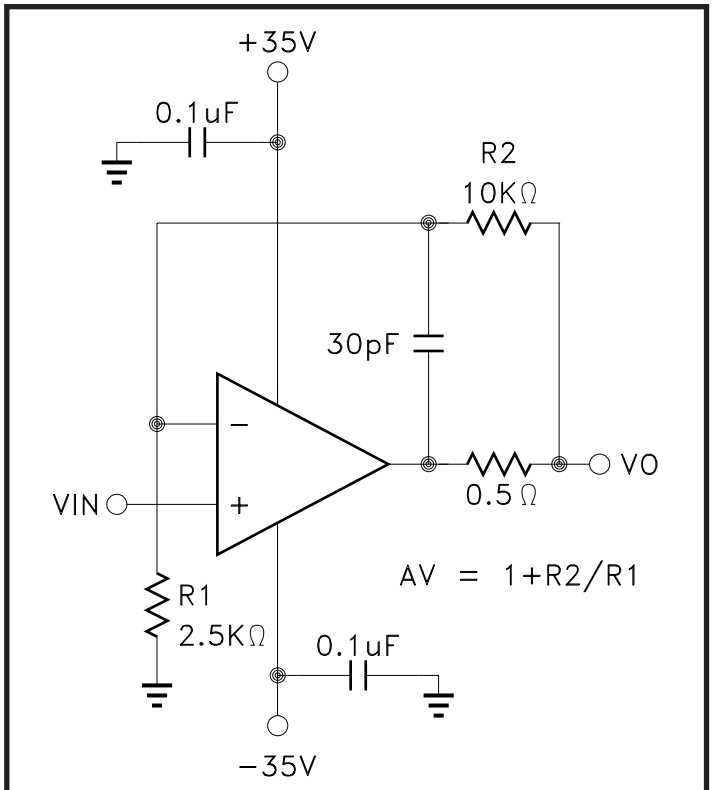


G = 1, CL = 4.7nF

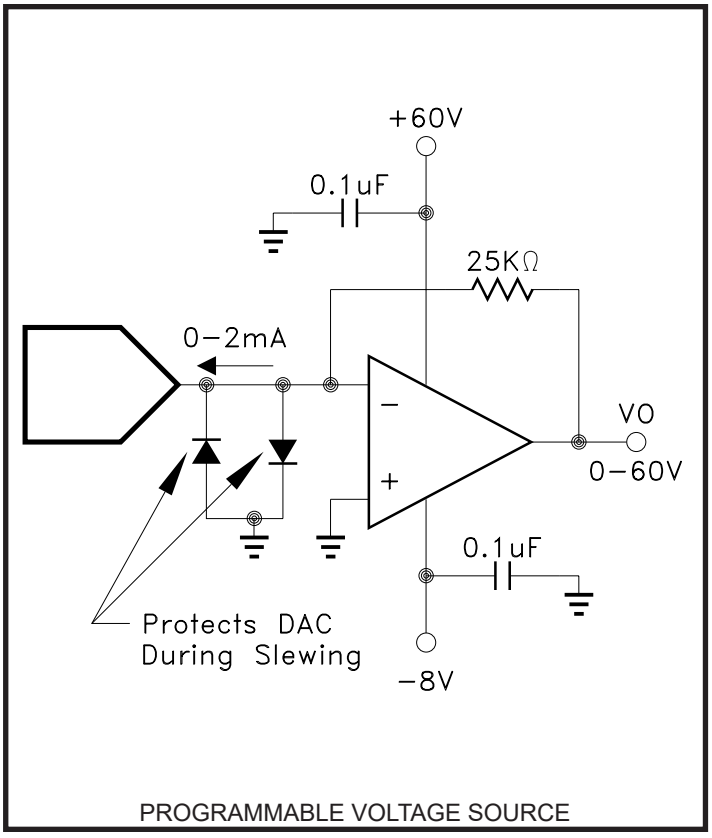
APPLICATION CIRCUITS



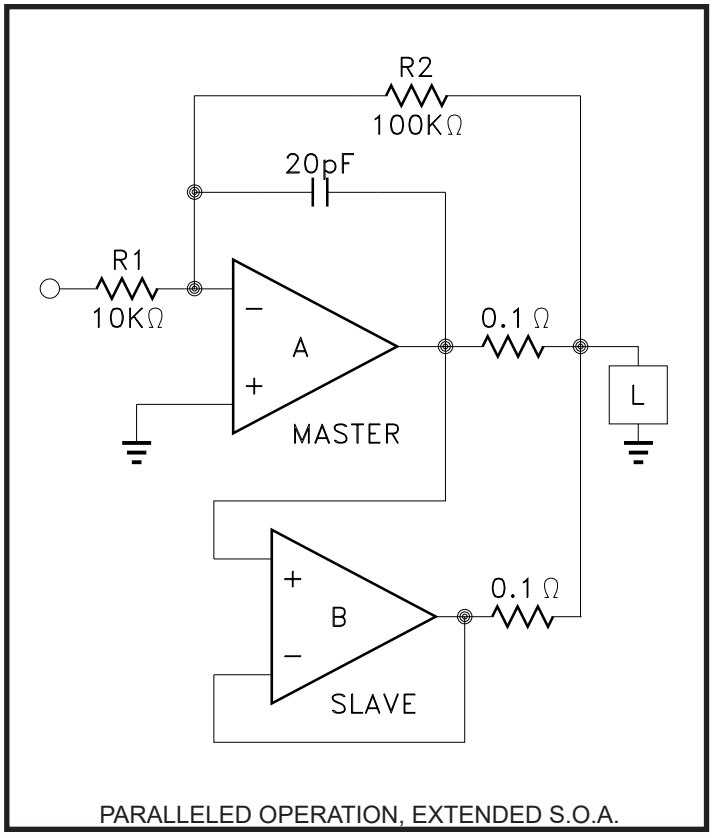
CLAMPING OUTPUT FOR EMF-GENERATING LOADS



ISOLATING CAPACITVE LOADS

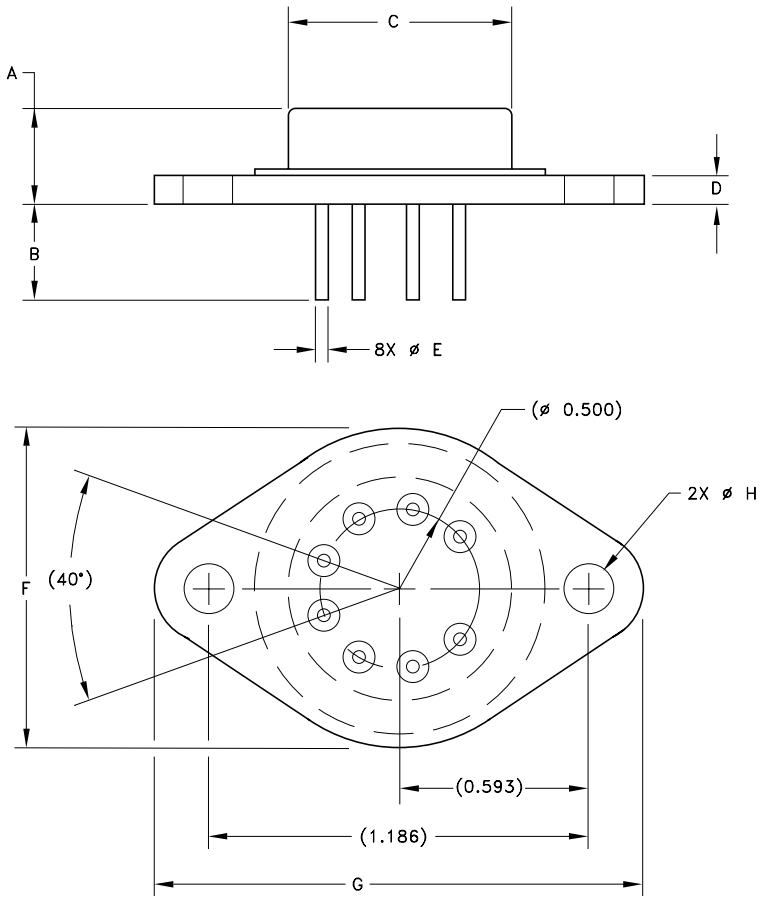


PROGRAMMABLE VOLTAGE SOURCE



PARALLELED OPERATION, EXTENDED S.O.A.

MECHANICAL SPECIFICATIONS



REF	MIN	MAX
A	0.260	0.340
B	0.400	0.500
C	0.745	0.770
D	0.080	0.105
E	0.038	0.042
F	0.980	1.020
G	1.510	1.550
H	0.151	0.161

WEIGHT=15.5 GRAMS TYPICAL

ALL DIMENSIONS ARE SPECIFIED IN INCHES

ORDERING INFORMATION

Part Number	Screening Level
MSK2541	Industrial
MSK2541B	MIL-PRF-38534, Class H
5962-9083801HX	DSCC-SMD
5962-9083803HX	DSCC-SMD

REVISION HISTORY

REV	STATUS	DATE	DESCRIPTION
I	Released	07/14	Format updates, assigned form number, added internal solder note, remove E version.
J	Released	09/17	Clarify GBD specification & update format

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